



Product Change Notification

Change Notification #: 115233 - 00
Change Title: Select Intel® SSD DC P3500 Series,
Intel® SSD DC P3600 Series,
Intel® SSD DC D3600 Series,
Intel® SSD DC P3700 Series,
Intel® SSD DC D3700 Series, and
Intel® SSD DC P3520 Series Products,
PCN 115233-00, Transport Media,
Packaging and Recycling Logo Update
Date of Publication: January 10, 2017

Key Characteristics of the Change:


Transport Media

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material:	January 25, 2017
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Description of Change to the Customer:

The Intel® SSD DC P3500 Series, Intel® SSD DC P3600 Series, Intel® SSD DC D3600 Series, Intel® SSD DC P3700 Series, Intel® SSD DC D3700 Series, and Intel® SSD DC P3520 Series SKUs listed in the Products Affected Table below will have the following changes to the Electrostatic Discharge (ESD) bag:

- Add South Korea Recycle Mark per regulatory 
- Changed the part number printed on the bag from G38222-001 to G38222-002
- Remove desiccant (G32570-001)

Please refer to the Current and New photos provided below:



Customer Impact of Change and Recommended Action:

There is no change to the form, fit, function, quality or reliability of the product. This change affects the printing on the ESD bag to comply with regulatory requirements.

Customers should be aware of the changes to the ESD bag and take appropriate actions to accommodate the changes and avoid impact to their process.

Intel will attempt to deplete pre-conversion material before shipping post-conversion material but there is a possibility of Intel shipping mixed inventory. Therefore, customers will need to manage and migrate to the post-conversion material as soon as possible.

Milestone dates are estimates and subject to change based on business and operational conditions.

Please contact your local Intel Field Sales Representative if you have any further questions about these changes.

Products Affected / Intel Ordering Codes:

Marketing Name	Product Code	MM#
Intel® SSD DC P3700 Series (400GB, 2.5in PCIe 3.0 x4, 20nm, MLC) Generic Single Pack	SSDPE2MD400G401	933079
Intel® SSD DC P3700 Series (800GB, 2.5in PCIe 3.0 x4, 20nm, MLC) Generic Single Pack	SSDPE2MD800G401	933080
Intel® SSD DC P3700 Series (1.6TB, 2.5in PCIe 3.0 x4, 20nm, MLC) Generic Single Pack	SSDPE2MD016T401	933081
Intel® SSD DC P3700 Series (2.0TB, 2.5in PCIe 3.0 x4, 20nm, MLC) Generic Single Pack	SSDPE2MD020T401	933082
Intel® SSD DC P3500 Series (2.0TB, 2.5in PCIe 3.0 x4, 20nm, MLC) Generic Single Pack	SSDPE2MX020T401	933086
Intel® SSD DC P3600 Series (400GB, 2.5in PCIe 3.0 x4, 20nm, MLC) Generic Single Pack	SSDPE2ME400G401	934670
Intel® SSD DC P3600 Series (800GB, 2.5in PCIe 3.0 x4, 20nm, MLC) Generic Single Pack	SSDPE2ME800G401	934671
Intel® SSD DC P3600 Series (1.2TB, 2.5in PCIe 3.0 x4, 20nm, MLC) Generic Single Pack	SSDPE2ME012T401	934672
Intel® SSD DC P3600 Series (1.6TB, 2.5in PCIe 3.0 x4, 20nm, MLC) Generic Single Pack	SSDPE2ME016T401	934673
Intel® SSD DC P3600 Series (2.0TB, 2.5in PCIe 3.0 x4, 20nm, MLC) Generic Single Pack	SSDPE2ME020T401	934674
Intel® SSD DC P3700 Series (400GB, 2.5in PCIe 3.0 x4, 20nm, MLC) Generic 10 Pack	SSDPE2MD400G410	937360
Intel® SSD DC P3700 Series (800GB, 2.5in PCIe 3.0 x4, 20nm, MLC) Generic 10 Pack	SSDPE2MD800G410	937361
Intel® SSD DC P3700 Series (1.6TB, 2.5in PCIe 3.0 x4, 20nm, MLC) Generic 10 Pack	SSDPE2MD016T410	937362
Intel® SSD DC P3700 Series (2.0TB, 2.5in PCIe 3.0 x4, 20nm, MLC) Generic 10 Pack	SSDPE2MD020T410	937363
Intel® SSD DC P3600 Series (400GB, 2.5in PCIe 3.0 x4, 20nm, MLC) Generic 10 Pack	SSDPE2ME400G410	937368
Intel® SSD DC P3600 Series (800GB, 2.5in PCIe 3.0 x4, 20nm, MLC) Generic 10 Pack	SSDPE2ME800G410	937370
Intel® SSD DC P3600 Series (1.2TB, 2.5in PCIe 3.0 x4, 20nm, MLC) Generic 10 Pack	SSDPE2ME012T410	937371
Intel® SSD DC P3600 Series (1.6TB, 2.5in PCIe 3.0 x4, 20nm, MLC) Generic 10 Pack	SSDPE2ME016T410	937372
Intel® SSD DC P3600 Series (2.0TB, 2.5in PCIe 3.0 x4, 20nm, MLC) Generic 10 Pack	SSDPE2ME020T410	937373
Intel® SSD DC P3500 Series (400GB, 2.5in PCIe 3.0 x4, 20nm, MLC) Generic Single Pack	SSDPE2MX400G401	937519
Intel® SSD DC P3500 Series (1.2TB, 2.5in PCIe 3.0 x4, 20nm, MLC) Generic Single Pack	SSDPE2MX012T401	937521
Intel® SSD DC P3500 Series (1.2TB, 2.5in PCIe 3.0 x4, 20nm, MLC) Generic 10 Pack	SSDPE2MX012T410	939932
Intel® SSD DC P3500 Series (2.0TB, 2.5in PCIe 3.0 x4, 20nm, MLC) Generic 10 Pack	SSDPE2MX020T410	939933
Intel® SSD DC P3520 Series (2.0TB, 2.5in PCIe 3.0 x4, 3D1, MLC) Generic Single Pack	SSDPE2MX020T701	943972
Intel® SSD DC P3520 Series (1.2TB, 2.5in PCIe 3.0 x4, 3D1, MLC) Generic Single Pack	SSDPE2MX012T701	943973
Intel® SSD DC P3520 Series (1.2TB, 2.5in PCIe 3.0 x4, 3D1, MLC) Generic 10 Pack	SSDPE2MX012T710	943981
Intel® SSD DC P3520 Series (2.0TB, 2.5in PCIe 3.0 x4, 3D1, MLC) Generic 10 Pack	SSDPE2MX020T710	943982
Intel® SSD DC D3600 Series (1.0TB, 2.5in PCIe 3.0 2x2, 20nm, MLC) Generic Single Pack	SSDPD2ME010T401	945557
Intel® SSD DC D3600 Series (2.0TB, 2.5in PCIe 3.0 2x2, 20nm, MLC) Generic Single Pack	SSDPD2ME020T401	945558
Intel® SSD DC D3700 Series (800GB, 2.5in PCIe 3.0 2x2, 20nm, MLC) Generic Single Pack	SSDPD2MD800G401	945559
Intel® SSD DC D3700 Series (1.6TB, 2.5in PCIe 3.0 2x2, 20nm, MLC) Generic Single Pack	SSDPD2MD016T401	945560
Intel® SSD DC P3520 Series (450GB, 2.5in PCIe 3.0 x4, 3D1, MLC) Generic Single Pack	SSDPE2MX450G701	948646

PCN Revision History:

Date of Revision:

January 10, 2017

Revision Number:

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Reason:

Originally Published PCN



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115233 - 00

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Americas Contact: asmo.pcn@intel.com

Asia Pacific/PRC Contact: apacgccb@intel.com

Europe Email: eccb@intel.com

Japan Email: jccb.ijkk@intel.com

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